MA2C178, MA2C179 (MA178, MA179)

Silicon epitaxial planar type

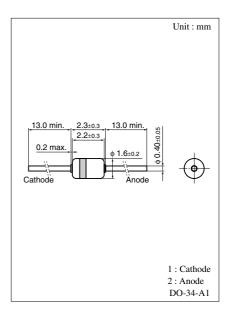
For high-speed switching circuits

■ Features

- Large forward current I_{FRM}
- High switching speed
- Small terminal capacitance, C_t

■ Absolute Maximum Ratings $T_a = 25$ °C

Paramete	er	Symbol	Rating	Unit
Reverse voltage	MA2C178	V_R	40	V
(DC)	MA2C179		80	
Repetitive peak	MA2C178	V_{RRM}	40	V
reverse voltage	MA2C179		80	
Average forward current		$I_{F(AV)}$	200	mA
Repetitive peak forward current		I_{FRM}	600	mA
Non-repetitive peak forward surge current*		I_{FSM}	1	A
Junction temperature		T _j	200	°C
Storage temperatur	re	T_{stg}	-55 to +200	°C



Note) * : t = 1 s

■ Electrical Characteristics $T_a = 25$ °C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	MA2C178	I_{R1}	$V_R = 15 \text{ V}$			50	nA
	MA2C179						
	MA2C178	I_{R2}	$V_R = 35 \text{ V}$			500	nA
	MA2C179		V _R = 75 V			500	
	MA2C178	I_R	$V_R = 35 \text{ V}, T_a = 150^{\circ}\text{C}$			100	μA
	MA2C179		$V_R = 75 \text{ V}, T_a = 150^{\circ}\text{C}$			100	
Forward voltage (DC)		V_F	$I_F = 200 \text{ mA}$			1.1	V
Terminal capacitance		C_{t}	$V_R = 0 V, f = 1 MHz$			4	pF
Reverse recovery time*		t _{rr}	$I_F = 10 \text{ mA}, V_R = 1 \text{ V}$			20	ns
			$I_{rr} = 0.1 \cdot I_{R}, R_{L} = 100 \Omega$				

Note) 1. Rated input/output frequency: 50 MHz

2. $*: t_{rr}$ measuring circuit

■ Cathode Indication

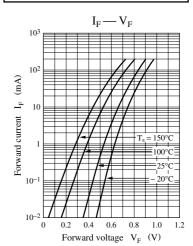
Type No.		MA2C178	MA2C179	
Color	1st Band	Violet	Violet	
	2nd Band	White	Green	

Note) The part numbers in the parenthesis show conventional part number.

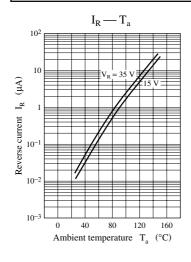
Bias Application Unit N-50BU Input Pulse Output Pulse $V_{R} = 0.1 \cdot I_{R}$ Pulse Generator W.F.Analyzer (PG-10N) (SAS-8130) $V_{R} = 50 \Omega$ $V_{R} = 0.1 \cdot I_{R}$ $V_{R} = 100 \Omega$

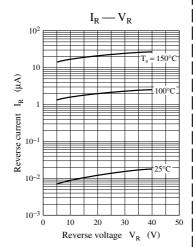
t_{rr}measuring circuit

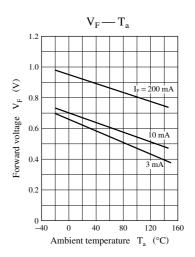
Common characteristics charts



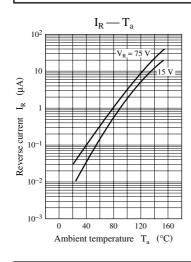
Characteristics charts of MA2C178

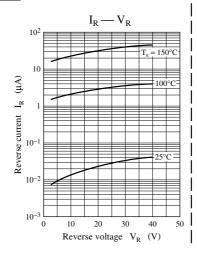


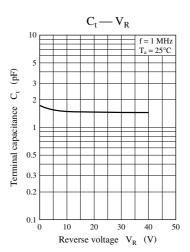




Characteristics charts of MA2C179







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